	Hits	Search Text	DBs	Time Stamp
1	2	"6274924".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/12/03 14:13
2	3815	LED adj chip	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/12/03 14:13
3	465	LED adj chip and lead adj frame	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/12/03 14:33
4	981	LED adj chip same (wire wires wiring)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/12/03 14:15
5	202	LED adj chip same (wire wires wiring) and lead adj frame	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/12/03 14:15
6	88	LED adj chip and lead adj frame and (bent bend bending)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 16:17
7	32	LED adj chip and lead adj frame same metal same (plated plating)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/12/03 14:16
8	51	LED adj chip and lead adj frame and transparent adj epoxy	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/12/03 14:34
9	8	LED adj chip and lead adj frame same metal same (plated plating) and transparent adj epoxy	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/12/03 14:23

	Hits	Search Text	DBs	Time Stamp
10	19	LED adj chip same (wire wires wiring) and lead adj frame and transparent adj epoxy	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/12/03 14:23
11	38	LED adj chip and lead adj frame same (bent bend bending)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/12/03 14:30
12	29	LED adj chip and lead adj frame same pattern	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/12/03 14:31
13	46	LED adj chip and lead adj frame and "438"/$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/12/03 14:33
14	6	LED adj chip and lead adj frame and transparent adj epoxy and "438"/$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/12/03 14:34
15	4	LED adj chip and lead adj frame and plating same metal and high adj reflectivity and diode and (molding mold molded) and (lead leads)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 18:37
16	78	LED adj chip and lead adj frame and (bent bend bending and fold folding folded)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 16:18
17	8	LED adj chip and lead adj frame and plating same metal and high adj reflectivity and (molding mold molded) and (lead leads)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 16:19
18	4	LED adj chip and lead adj frame and plating same metal and high adj reflectivity and (molding mold molded) and (lead leads) and electrode	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 16:20

	Hits	Search Text	DBs	Time Stamp
19	29	LED adj chip and lead adj frame and plating same metal and (molding mold molded) and (lead leads) and electrode	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 16:20
20	324	438/26.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 16:22
21	177	438/28.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 16:22
22	229	438/33.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 16:22
23	307	438/34.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 16:22
24	86	438/35.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 16:22
25	2786	438/106.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 16:22
26	1041	438/107.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 16:22
27	492	438/112.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 16:22

	Hits	Search Text	DBs	Time Stamp
28	825	438/113.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 16:22
29	0	LED adj chip and lead adj frame and Ag same Au same Pd same Mi same Cr	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 18:38
30	32	LED adj chip and lead adj frame same (Ag Au Pd Mi Cr)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 18:39
31	33	LED adj chip and lead adj frame same (Ag Au Pd Ni Cr)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 18:41
32	21	LED adj chip and (lead adj frame leadframe) with (Ag Au Pd Ni Cr)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 18:41
33	36	LED adj chip and (lead adj frame leadframe) same (Ag Au Pd Ni Cr)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 18:47
34	258	LED and (lead adj frame leadframe) same (Ag Au Pd Ni Cr)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 18:47
35	156	LED and (lead adj frame leadframe) with (Ag Au Pd Ni Cr)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 18:47
36	104	LED and (lead adj frame leadframe) with (Ag Au Pd Ni Cr) and electrode	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 18:47

	Hits	Search Text	DBs	Time Stamp
37	53	LED and (lead adj frame leadframe) with (Ag Au Pd Ni Cr) and electrode and (bent bend bening fold folded folding)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 18:48
38	57	LED and (lead adj frame leadframe) with (Ag Au Pd Ni Cr) and electrode and (bent bend bending fold folded folding)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/07 18:48